

UNISONIC TECHNOLOGIES CO., LTD

26N50 **Preliminary Power MOSFET**

26A, 500V N-CHANNEL **POWER MOSFET**

DESCRIPTION

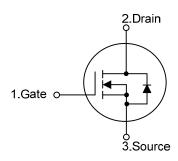
The UTC 26N50 is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 26N50 is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.



- * $R_{DS(ON)} \le 0.24\Omega$ @ $V_{GS}=10V$, $I_{D}=13A$
- * High Switching Speed
- * 100% Avalanche Tested

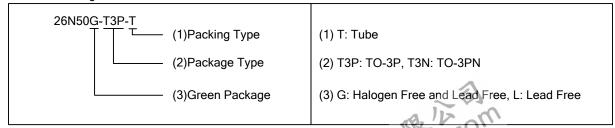
SYMBOL



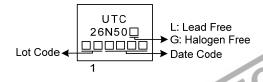
ORDERING INFORMATION

Ordering Number		Dookono	Pin Assignment			Doolsing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
26N50L-T3P-T	26N50G-T3P-T	TO-3P	G	D	S	Tube	
26N50L-T3N-T	26N50G-T3N-T	TO-3PN	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



TO-3P TO-3PN

www.unisonic.com.tw 1 of 6

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous (T _C =25°C)	I_{D}	26 (Note 2)	Α
	Pulsed (Note 3)	I_{DM}	96 (Note 2)	Α
Avalanche Current (Note 3)		I_{AR}	26	Α
Avalanche Energy	Single Pulsed (Note 4)	E _{AS}	1100	mJ
	Repetitive (Note 5)	E_{AR}	29	mJ
Peak Diode Recovery dv/dt (Note 5)		dv/dt	15	V/ns
Power Dissipation		J	290	W
Derate above 25°C		P_D	2.33	W/°C
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Drain current limited by maximum junction temperature.
- 3. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 4. L =3.4mH, I_{AS} = 26A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 5. $I_{SD} \le 26A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	40	°C/W	
Junction to Case	θ_{JC}	0.43	°C/W	



■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

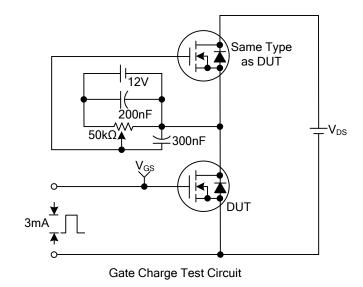
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	500			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V			50	μΑ
Gate- Source Leakage Current Forward		V_{GS} =+30V, V_{DS} =0V			+100	nA
Reverse	I_{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =13A		0.15	0.24	Ω
DYNAMIC PARAMETERS			-a			
Input Capacitance	C _{ISS}			3500	4500	pF
Output Capacitance	Coss	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		520	670	pF
Reverse Transfer Capacitance	C _{RSS}			55	70	pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	V -40V V -400V I -26A		90	120	nC
Gate to Source Charge	Q_GS	V _{GS} =10V, V _{DS} =400V, I _D =26A (Note 1, 2)		23		nC
Gate to Drain Charge	Q_{GD}	(Note 1, 2)		52		nC
Turn-ON Delay Time	t _{D(ON)}			80	170	ns
Rise Time	t_R	V_{DD} =250V, I_{D} =26A, R_{G} =25 Ω		250	500	ns
Turn-OFF Delay Time	t _{D(OFF)}	(Note 1, 2)		200	400	ns
Fall-Time	t _F			155	320	ns
SOURCE- DRAIN DIODE RATINGS AND	CHARACTER	ISTICS				
Maximum Body-Diode Continuous Current	Is				24	Α
Maximum Body-Diode Pulsed Current	I _{SM}				96	Α
Drain-Source Diode Forward Voltage	V_{SD}	I _S =26A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time	t _{rr}	I _S =26A, V _{GS} =0V,		250		ns
Body Diode Reverse Recovery Charge	Qrr	dI _F /dt=100A/μs (Note 1)		1.1		μC

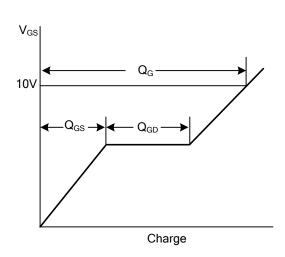
Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.



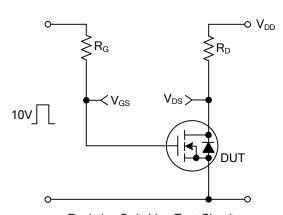
^{2.} Essentially independent of operating temperature.

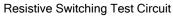
■ TEST CIRCUITS AND WAVEFORMS

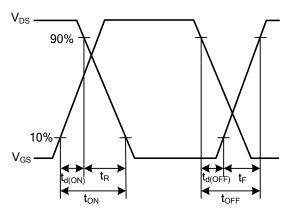




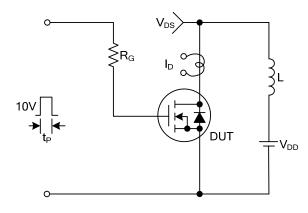
Gate Charge Waveforms



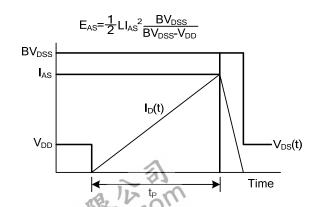




Resistive Switching Waveforms



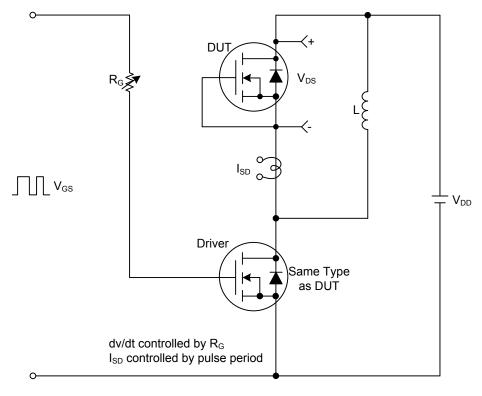
Unclamped Inductive Switching Test Circuit

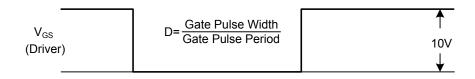


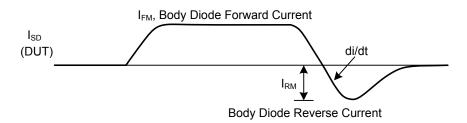
Unclamped Inductive Switching Waveforms

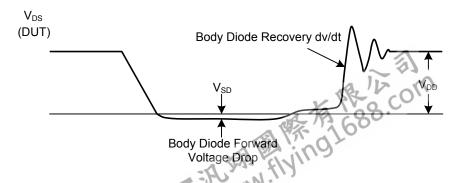
■ TEST CIRCUITS AND WAVEFORMS(Cont.)

Peak Diode Recovery dv/dt Test Circuit & Waveforms









UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.